

## PRODUCT/PROCESS CHANGE NOTICE (PCN)

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Product Affected: QS3VH861	15/01	MEANS OF DISTIN  Product Mark Back Mark Date Code Other	IGUISHING CHANC	GED DEVICES:
Date Effective: 10/15/01		□ Otner		
Contact: Bimla Paul			_	
Title: Product Assurance Manager		Attachment::	Yes	∐ No
Phone #: 408-654-6419				
Fax #: 408-492-8362		Samples:	N/A	
E-mail: <u>Bimla.Paul@idt.com</u>				
DESCRIPTION AND PURPOSE OF CHANGE:  ☐ Die Technology ☐ Wafer Fabrication Process To modify c ☐ Assembly Process ☐ Equipment ☐ Material ☐ Testing ☐ Manufacturing Site ☐ Data Sheet ☐ Other	current Icc	q data sheet specifica	tion from 1.5mA to 3.	0 mA
RELIABILITY/QUALIFICATION SUMMARY Not Applicable. The datasheet limit for Iccq has been revised for yield enhancement				
CUSTOMER ACKNOWLEDGMENT OF RECEIPT:  IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.  IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.				
Customer:		Approval for	shipments prior to	effective date.
Name/Date:	E-N	Mail Address:		
Title:	Pho	one# /Fax# :		
CUSTOMER COMMENTS:				
IDT ACKNOWLEDGMENT OF RECEIPT:				
RECD. BY:		DATE:		_



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## ATTACHMENT - PCN #: L0109-01

**PCN Type:** Data Sheet Change

**Data Sheet Change:** Yes

**Detail of Change:** 

From:

Symbol Parameter Test Conditions Max

Iccq Quiescent Power Supply Current Vcc=max, Vin =Gnd or Vcc, f=0 1.5 mA

To:

Symbol Parameter Test Conditions Max

Iccq Quiescent Power Supply Current Vcc=max, Vin =Gnd or Vcc, f=0 3.0 mA

Conversion schedule (Estimated) 10/15/01